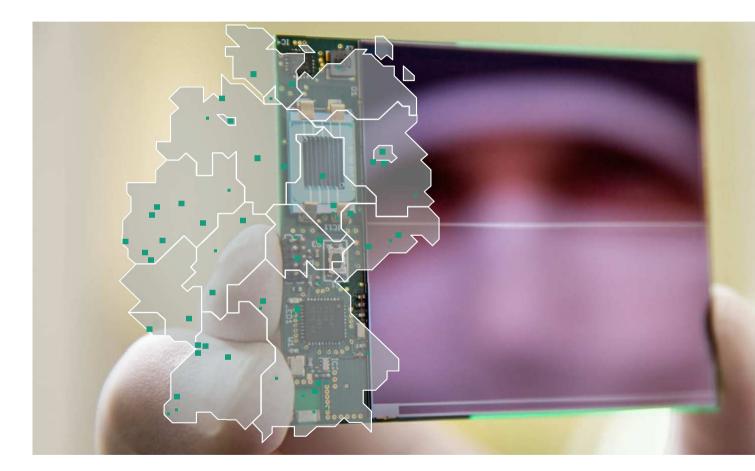


Strategies for more Circularity in the Life Cycle of Mobile Information Technology

Karsten Schischke, Marina Proske, Miquel Ballester, Julia Reinhold, Klaus-Dieter Lang, Max Regenfelder



Overview Fraunhofer Gesellschaft



• 72 institutes

- >25,000 employees
- app. 2.3 billion € turnover
- More than 70% contract research

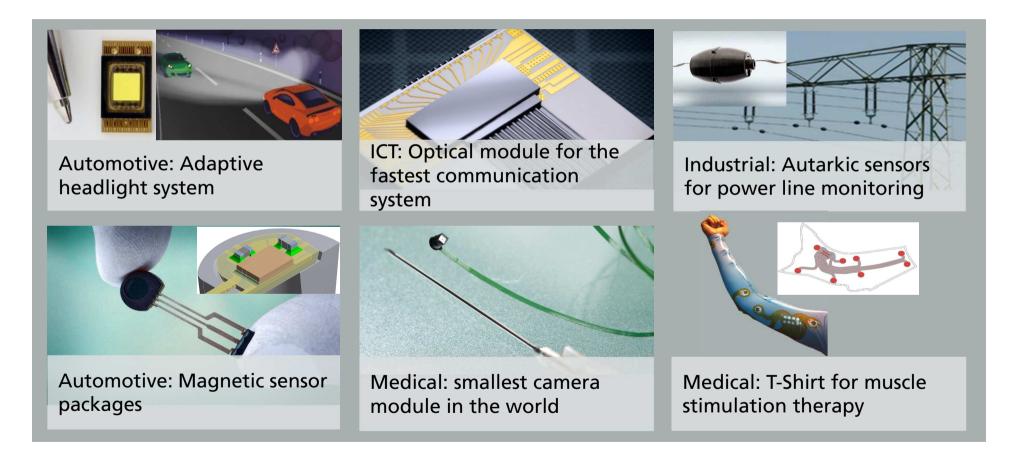
Groups:

- Information Technology
- Light & Surfaces
- Life Sciences
- Microelectronics
- Production
- Defense & Security
- Materials & Components

Schischke, Environmental and Reliability Engineering



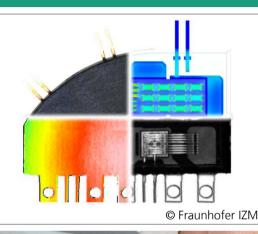
Fraunhofer IZM in a Nutshell: Advanced Technologies for Microelectronic Packaging



Schischke, Environmental and Reliability Engineering



Environmental and Reliability Engineering @ Fraunhofer IZM





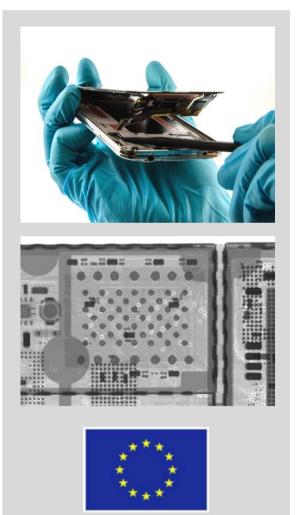
- Ageing mechanisms of microelectronics (thermal, mechanical, moisture)
- Combined load lifetime testing, accelerated test
- Assessment of warpage issues
- Corrosion issues in microelectronics
- Condition monitoring and lifetime estimation
- Lifecycle environmental assessments (LCA, PCF)
- Ecodesign concepts for products and ICT systems
- Resource utilization and critical materials in electronics
- Circular economy, obsolescence, and design for recycling

Schischke, Environmental and Reliability Engineering



sustainablySMART





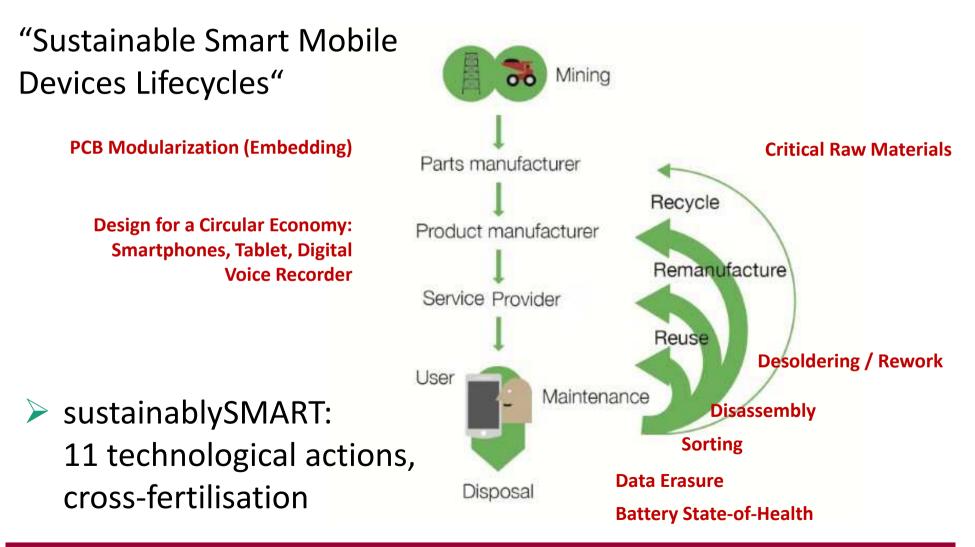
Project website

- www.sustainably-smart.eu
- Partners
 - Fairphone, Circular Devices, MicroPro, AT&S, ITR, Semicon, Refind Technologies, Pro Automation, Blancco, Grant4Com, ReUse, iFixit, Speech, TU Wien, SAT, PrimeTel, Fraunhofer IZM
- Project starting date: September 2015
- Project end date: October 2019
- Funding:
 - The project sustainablySMART has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement no. 680640.



Project Objectives

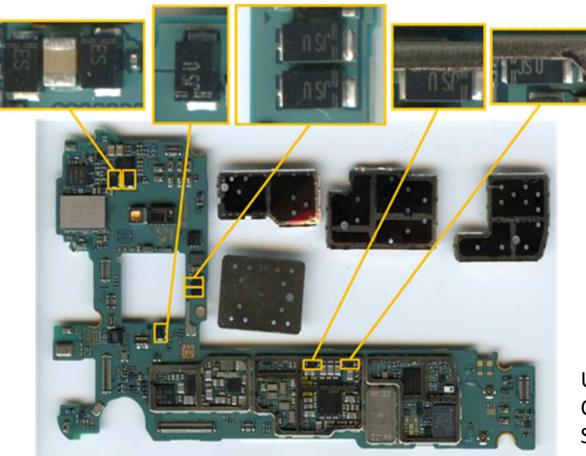








Recovery of Tantalum

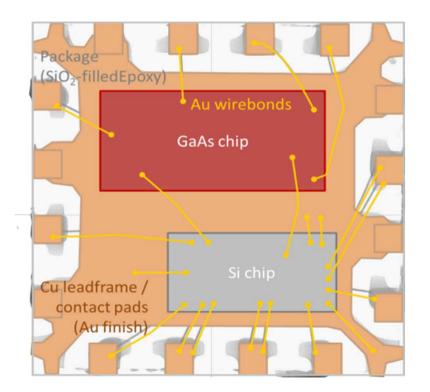


Use of Tantalum Capacitors in the Samsung Galaxy S7





Recovery of Gallium



WLAN module with GaAs and silicon chips in one package





Recovery of Tungsten







Recycling Potential

	Та	Ga	W
Target component	Tantalum capacitors	GaAs modules	Vibration motors
Existing recycling process	yes	no	no
for post-consumer scrap			
Recycling of post- consumer scrap	yes , large scale processes for post-industrial scrap in	no (Ga content too low)	requires pre-processing of vibration motors to
potentially feasible	place		separate the heavy metal from motor parts
Recovery of contained precious metals feasible	yes (Ag)	no	not clear yet
Material value per phone	< 0,2 €-cents	< 0,03 €-cents	max. 1,8 €-cents
Economically viable	no	no	depends on overall disassembly process
High environmental impact of primary material	no	no	no
Conflict minerals	yes	no	yes

Karsten Schischke





Fairphone 2



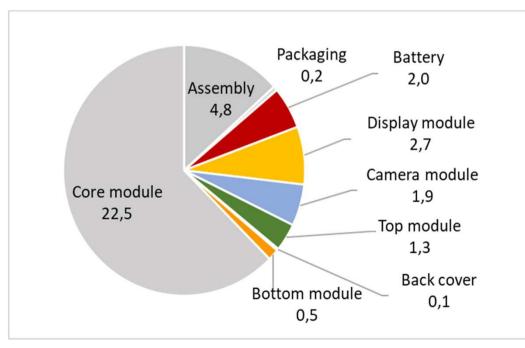


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Fairphone 2

Global Warming Potential of Module Production, Assembly and Packaging

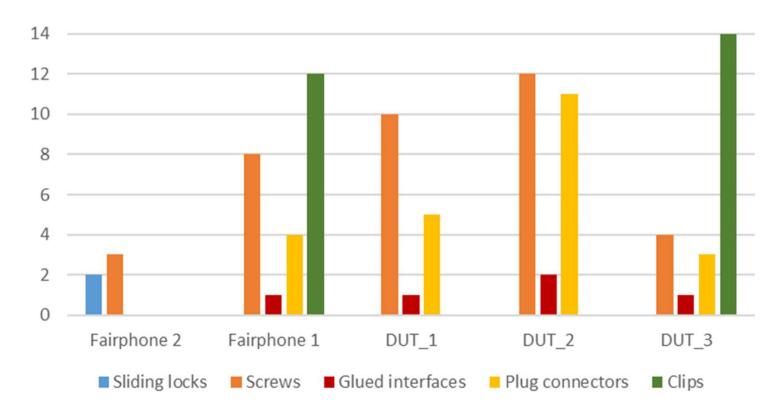






Fairphone 2

Fasteners to Disassemble the Rear Camera







Fairphone 2

Repair instructions by iFixit

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Step 3	

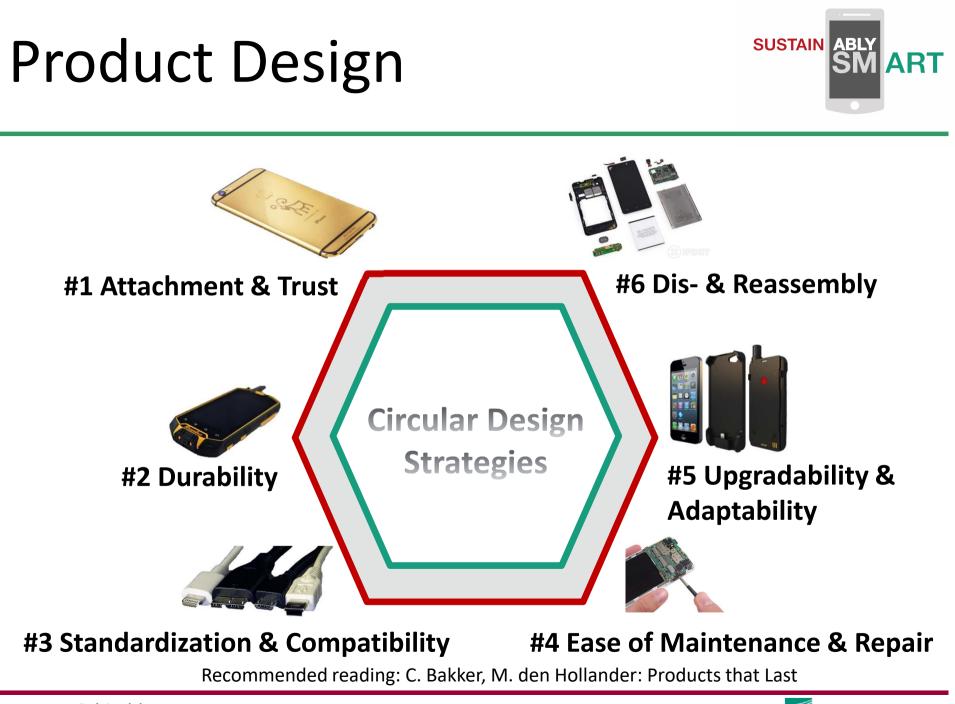






Fairphone 2: Modularity for reparability PuzzlePhone: Open-standard modularity Digital Voice Recorder: B2B product 









Fairphone 2: Modularity for reparability PuzzlePhone: Open-standard modularity

DVR: B2B product then and initial judgement might not

Initial judgement as of March 2016, design priorities have changed since

have been

accurate

Circular Design Strategy	Fairphone 2	Puzzlephone	Digital Voice Recorder	iameco D4R tablet
Attachment & Trust	C	А	А	С
Durability	Α	Α	А	В
Standardization and Compatibility	В	А	В	В
Ease of Maintenance & Repair	А	В	C	A
Upgradability & Adaptability	В	A	В	A
Dis- & Reassembly	В	с	С	A

Table 1: Circular Design Strategies – Self Assessment (ABC-Analysis)

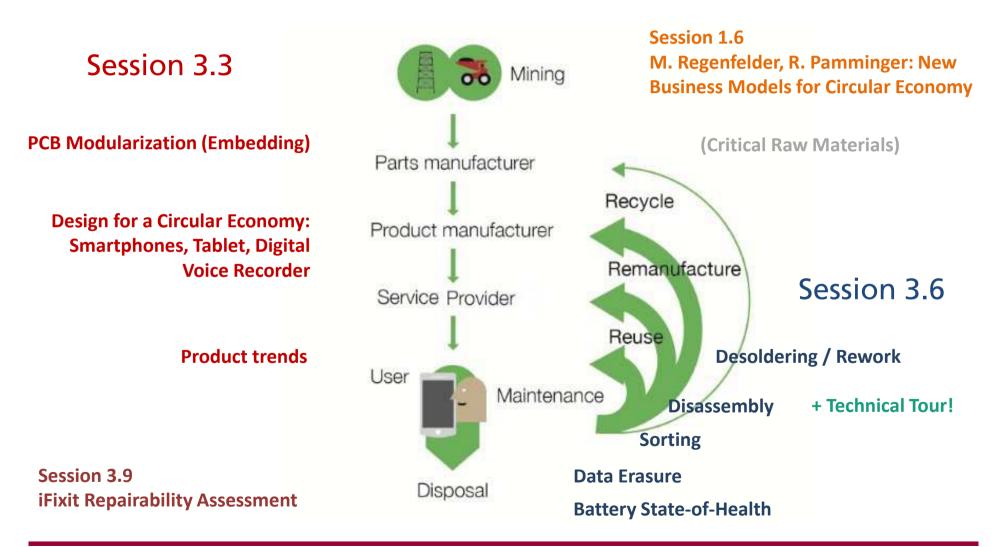
A: most important; B: moderately important; C: less important than other design strategies

Key message: Even for similar products a Circular Design approach might look very different



Presentations







Karsten Schischke